

Kazuhide Kumakura

List of Publications by Year in descending order

Source: <https://exaly.com/author-pdf/4122294/publications.pdf>

Version: 2024-02-01

101
papers

2,207
citations

257450

24
h-index

243625

44
g-index

102
all docs

102
docs citations

102
times ranked

2123
citing authors

#	ARTICLE	IF	CITATIONS
1	Layered boron nitride as a release layer for mechanical transfer of GaN-based devices. Nature, 2012, 484, 223-227.	27.8	359
2	Minority carrier diffusion length in GaN: Dislocation density and doping concentration dependence. Applied Physics Letters, 2005, 86, 052105.	3.3	198
3	Mg-acceptor activation mechanism and transport characteristics in p-type InGaN grown by metalorganic vapor phase epitaxy. Journal of Applied Physics, 2003, 93, 3370-3375.	2.5	124
4	Activation Energy and Electrical Activity of Mg in Mg-Doped In _x Ga _{1-x} N (x<0.2). Japanese Journal of Applied Physics, 2000, 39, L337-L339.	1.5	94
5	Al ₂ O ₃ Insulated-Gate Structure for AlGaN/GaN Heterostructure Field Effect Transistors Having Thin AlGaN Barrier Layers. Japanese Journal of Applied Physics, 2004, 43, L777-L779.	1.5	79
6	High current gains obtained by InGaN/GaN double heterojunction bipolar transistors with p-InGaN base. Applied Physics Letters, 2001, 79, 380-381.	3.3	66
7	Increased Electrical Activity of Mg-Acceptors in Al _x Ga _{1-x} N/GaN Superlattices. Japanese Journal of Applied Physics, 1999, 38, L1012-L1014.	1.5	60
8	Low-resistance nonalloyed ohmic contact to p-type GaN using strained InGaN contact layer. Applied Physics Letters, 2001, 79, 2588-2590.	3.3	55
9	High hole concentrations in Mg-doped InGaN grown by MOVPE. Journal of Crystal Growth, 2000, 221, 267-270.	1.5	53
10	High-power characteristics of GaN/InGaN double heterojunction bipolar transistors. Applied Physics Letters, 2004, 84, 1964-1966.	3.3	53
11	Suppression of self-heating effect in AlGaN/GaN high electron mobility transistors by substrate-transfer technology using h-BN. Applied Physics Letters, 2014, 105, .	3.3	53
12	Novel Formation Method of Quantum Dot Structures by Self-Limited Selective Area Metalorganic Vapor Phase Epitaxy. Japanese Journal of Applied Physics, 1995, 34, 4387-4389.	1.5	51
13	Formation and characterization of coupled quantum dots (CQDs) by selective area metalorganic vapor phase epitaxy. Journal of Crystal Growth, 1997, 170, 700-704.	1.5	44
14	Efficient Hole Generation above 10^{19} cm ⁻³ in Mg-Doped InGaN/GaN Superlattices at Room Temperature. Japanese Journal of Applied Physics, 2000, 39, L195.	1.5	44
15	Oxygen Ion Implantation Isolation Planar Process for AlGaN/GaN HEMTs. IEEE Electron Device Letters, 2007, 28, 476-478.	3.9	44
16	High current gain (>2000) of GaN/InGaN double heterojunction bipolar transistors using base regrowth of p-InGaN. Applied Physics Letters, 2003, 83, 1035-1037.	3.3	41
17	Enhanced Hole Generation in Mg-Doped AlGaN/GaN Superlattices Due to Piezoelectric Field. Japanese Journal of Applied Physics, 2000, 39, 2428-2430.	1.5	39
18	A Vertical InGaN/GaN Light-Emitting Diode Fabricated on a Flexible Substrate by a Mechanical Transfer Method Using BN. Applied Physics Express, 2012, 5, 072102.	2.4	39

#	ARTICLE	IF	CITATIONS
19	Unintentional Ga incorporation in metalorganic vapor phase epitaxy of In-containing III-nitride semiconductors. <i>Journal of Crystal Growth</i> , 2013, 382, 36-40.	1.5	36
20	High hole concentration in Mg-doped AlN/AlGaN superlattices with high Al content. <i>Japanese Journal of Applied Physics</i> , 2018, 57, 04FH09.	1.5	35
21	Reduced damage of electron cyclotron resonance etching by In doping into p-GaN. <i>Journal of Crystal Growth</i> , 2000, 221, 350-355.	1.5	32
22	High Critical Electric Field Exceeding 8 MV/cm Measured Using an AlGaNP Vertical Conducting Diode on n-SiC Substrate. <i>Japanese Journal of Applied Physics</i> , 2007, 46, 2316-2319.	1.5	32
23	InAs quantum dot formation on GaAs pyramids by selective area MOVPE. <i>Physica E: Low-Dimensional Systems and Nanostructures</i> , 1998, 2, 714-719.	2.7	29
24	High critical electric field of Al _x Ga _{1-x} N p-i-n vertical conducting diodes on n-SiC substrates. <i>Applied Physics Letters</i> , 2006, 88, 173508.	3.3	29
25	Valence-band discontinuities between InGaN and GaN evaluated by capacitance-voltage characteristics of p-InGaN/n-GaN diodes. <i>Journal of Electronic Materials</i> , 2002, 31, 313-315.	2.2	24
26	Ohmic Contact top-GaN Using a Strained InGaN Contact Layer and Its Thermal Stability. <i>Japanese Journal of Applied Physics</i> , 2003, 42, 2254-2256.	1.5	21
27	Minority carrier diffusion lengths in MOVPE-grown n- and p-InGaN and performance of AlGaN/InGaN/GaN double heterojunction bipolar transistors. <i>Journal of Crystal Growth</i> , 2007, 298, 787-790.	1.5	19
28	Extrinsic Base Regrowth of p-InGaN for Npn-Type GaN/InGaN Heterojunction Bipolar Transistors. <i>Japanese Journal of Applied Physics</i> , 2004, 43, 1922-1924.	1.5	18
29	Epitaxial growth of monolayer MoSe ₂ on GaAs. <i>Applied Physics Express</i> , 2016, 9, 115501.	2.4	17
30	DC and microwave performance of AlGaN/GaN HEMTs passivated with sputtered SiNx. <i>Semiconductor Science and Technology</i> , 2007, 22, 717-721.	2.0	16
31	Control of n-type electrical conductivity for cubic boron nitride (c-BN) epitaxial layers by Si doping. <i>Applied Physics Letters</i> , 2020, 116, 162104.	3.3	15
32	GaAs Single Electron Transistors Fabricated by Selective Area Metalorganic Vapor Phase Epitaxy and Their Application to Single Electron Logic Circuits. <i>Japanese Journal of Applied Physics</i> , 1999, 38, 415-417.	1.5	14
33	Common-emitter current-voltage characteristics of a pnp GaN bipolar junction transistor. <i>Applied Physics Letters</i> , 2002, 80, 1225-1227.	3.3	14
34	Heteroepitaxial growth of single-domain cubic boron nitride films by ion-beam-assisted MBE. <i>Applied Physics Express</i> , 2017, 10, 035501.	2.4	14
35	Structural analysis of cubic boron nitride (111) films heteroepitaxially grown on diamond (111) substrates. <i>Journal of Applied Physics</i> , 2019, 125, .	2.5	14
36	High-Temperature Performance of AlN MESFETs With Epitaxially Grown n-Type AlN Channel Layers. <i>IEEE Electron Device Letters</i> , 2022, 43, 350-353.	3.9	14

#	ARTICLE	IF	CITATIONS
37	Growth of GaN on sapphire substrates using novel buffer layers of ECR-plasma-sputtered Al ₂ O ₃ /graded-AlON/AlN/Al ₂ O ₃ . Journal of Crystal Growth, 2006, 292, 155-158.	1.5	13
38	Dynamics of selective metalorganic vapor phase epitaxy growth for GaAs/AlGaAs micro-pyramids. Journal of Crystal Growth, 1994, 145, 308-313.	1.5	12
39	Fabrication of GaAs/AlGaAs Quantum Dots by Metalorganic Vapor Phase Epitaxy on Patterned GaAs Substrates. Japanese Journal of Applied Physics, 1995, 34, 1098-1101.	1.5	12
40	Epitaxial Heusler alloy Co ₂ FeSi films on Si(100) substrates grown by molecular beam epitaxy. Journal Physics D: Applied Physics, 2010, 43, 305004.	2.8	12
41	High Current Gains Obtained by InGaN/GaN Double Heterojunction Bipolar Transistors. Physica Status Solidi A, 2001, 188, 183-186.	1.7	11
42	N-AlGaIn/p-InGaIn/n-GaN Heterojunction Bipolar Transistors for High Power Operation. Physica Status Solidi C: Current Topics in Solid State Physics, 2003, 0, 95-98.	0.8	11
43	High power operation of Pnp AlGaIn/GaN heterojunction bipolar transistors. Physica Status Solidi C: Current Topics in Solid State Physics, 2005, 2, 2589-2592.	0.8	11
44	High-voltage operation with high current gain of pnp AlGaIn-GaN heterojunction bipolar transistors with thin n-type GaN base. Applied Physics Letters, 2005, 86, 023506.	3.3	11
45	Current-voltage characteristics of p-InGaIn-n-GaN vertical conducting diodes on n-SiC substrates. Applied Physics Letters, 2005, 87, 233505.	3.3	11
46	High-temperature characteristics up to 590°C of a pnp AlGaIn/GaN heterojunction bipolar transistor. Applied Physics Letters, 2009, 94, .	3.3	11
47	Infinite-layer phase formation in the Ca _x Sr _x CuO ₂ system by reactive molecular beam epitaxy. Journal of Applied Physics, 2018, 124, .	2.5	11
48	Ohmic contact to AlN:Si using graded AlGaIn contact layer. Applied Physics Letters, 2019, 115, .	3.3	11
49	High performance pnp AlGaIn-GaN heterojunction bipolar transistors on GaN substrates. Applied Physics Letters, 2008, 92, .	3.3	10
50	Fabrication and transport characterization of GaAs quantum dots connected with quantum wires fabricated by selective area metalorganic vapor phase epitaxy. Physica E: Low-Dimensional Systems and Nanostructures, 1998, 2, 809-814.	2.7	9
51	Common-emitter current-voltage characteristics of a Pnp AlGaIn/GaN heterojunction bipolar transistor with a low-resistance base layer. Applied Physics Letters, 2002, 80, 3841-3843.	3.3	9
52	Critical electric fields of AlGaIn in AlGaIn-based vertical conducting diodes on -SiC substrates. Superlattices and Microstructures, 2006, 40, 332-337.	3.1	9
53	High electron concentrations in Si-doped AlN/AlGaIn superlattices with high average Al content of 80%. Physica Status Solidi A, 2003, 200, 40-43.	1.7	8
54	Efficient heat dissipation in AlGaIn/GaN high electron mobility transistors by substrate-transfer technique. Physica Status Solidi (A) Applications and Materials Science, 2017, 214, .	1.8	8

#	ARTICLE	IF	CITATIONS
55	Pyramidal quantum dot structures by self-limited selective area metalorganic vapor phase epitaxy. <i>Solid-State Electronics</i> , 1996, 40, 799-802.	1.4	7
56	Low Resistance Non-Alloy Ohmic Contact to p-Type GaN Using Mg-Doped InGaN Contact Layer. <i>Physica Status Solidi A</i> , 2001, 188, 363-366.	1.7	7
57	Temperature dependence of current-voltage characteristics of npn-type GaN ⁺ /InGaN double heterojunction bipolar transistors. <i>Applied Physics Letters</i> , 2007, 91, 133514.	3.3	7
58	Influence of Metalorganic Vapor Phase Epitaxy Regrowth on Characteristics of InAlN/AlGaIn/GaN High Electron Mobility Transistors. <i>Japanese Journal of Applied Physics</i> , 2013, 52, 04CF02.	1.5	7
59	Enhancement of performance of AlGaIn/GaN high-electron-mobility transistors by transfer from sapphire to a copper plate. <i>Japanese Journal of Applied Physics</i> , 2016, 55, 05FH07.	1.5	7
60	Plasmon Control Driven by Spatial Carrier Density Modulation in Graphene. <i>ACS Photonics</i> , 2019, 6, 947-952.	6.6	7
61	Strained Thick p-InGaIn Layers for GaN/InGaIn Heterojunction Bipolar Transistors on Sapphire Substrates. <i>Japanese Journal of Applied Physics</i> , 2005, 44, 2722-2725.	1.5	6
62	Long-range order and thermal stability of thin Co ₂ FeSi films on GaAs(111)B. <i>Journal Physics D: Applied Physics</i> , 2010, 43, 285404.	2.8	6
63	Transport characterization of GaAs quantum dots connected with quantum wires fabricated by selective area metalorganic vapor phase epitaxy. <i>Solid-State Electronics</i> , 1998, 42, 1227-1231.	1.4	5
64	Surface supersaturation in flow-rate modulation epitaxy of GaN. <i>Journal of Crystal Growth</i> , 2017, 468, 821-826.	1.5	5
65	High Room-Temperature Hole Concentrations above 10^{19} cm ⁻³ in Mg-Doped InGaIn/GaN Superlattices. <i>Materials Research Society Symposia Proceedings</i> , 2000, 622, 5111.	0.1	4
66	Schottky barrier heights of Au, Pd and Ni on n-GaN evaluated using mesa-structure diodes. <i>Physica Status Solidi C: Current Topics in Solid State Physics</i> , 2003, 0, 2393-2395.	0.8	4
67	High breakdown voltage with low on-state resistance of p-InGaIn ⁺ /n-GaN vertical conducting diodes on n-GaN substrates. <i>Applied Physics Letters</i> , 2006, 89, 153509.	3.3	4
68	Influence of Lattice Constants of GaN and InGaIn on npn-Type GaN/InGaIn Heterojunction Bipolar Transistors. <i>Japanese Journal of Applied Physics</i> , 2006, 45, 3395-3397.	1.5	4
69	Low on-resistance of GaNp-i-n vertical conducting diodes grown on 4H-SiC substrates. <i>Physica Status Solidi C: Current Topics in Solid State Physics</i> , 2007, 4, 2662-2665.	0.8	4
70	Carrier transport mechanisms of Pnp AlGaIn ⁺ /GaN heterojunction bipolar transistors. <i>Applied Physics Letters</i> , 2008, 92, 093504.	3.3	4
71	Surface morphology control of nonpolar c-plane AlN homoepitaxial layers by flow-rate modulation epitaxy. <i>Physica Status Solidi (B): Basic Research</i> , 2017, 254, 1600545.	1.5	4
72	N-face GaN/InN/GaN double heterostructures emitting near-infrared photoluminescence grown by metalorganic vapor phase epitaxy. <i>Applied Physics Express</i> , 2018, 11, 081001.	2.4	4

#	ARTICLE	IF	CITATIONS
73	High breakdown field of pnp GaN/InGaN/AlGaN DHBTs with AlGaN collector. Physica Status Solidi (A) Applications and Materials Science, 2007, 204, 2037-2041.	1.8	3
74	A new AlON buffer layer for RF-MBE growth of AlN on a sapphire substrate. Journal of Crystal Growth, 2015, 425, 138-140.	1.5	3
75	Molecular beam epitaxy of Nd ₂ PdO ₄ thin films. AIP Advances, 2017, 7, 075006.	1.3	3
76	Pnp AlGaIn/GaN Heterojunction Bipolar Transistors Operating at 300 K. Physica Status Solidi A, 2002, 194, 443-446.	1.7	2
77	Systematic investigation of minority carrier diffusion length in n- and p-GaN for nitride heterojunction bipolar transistors. , 0, , .		2
78	p-InGaIn/n-GaN Vertical Conducting Diodes on n-SiC Substrate for High Power Electronic Device Applications. Japanese Journal of Applied Physics, 2006, 45, 3387-3390.	1.5	2
79	Low-resistance graded Al _x Ga _{1-x} N buffer layers for vertical conducting devices on n-SiC substrates. Journal of Crystal Growth, 2007, 298, 819-821.	1.5	2
80	High-Temperature Characteristics of Al _x Ga _{1-x} N-Based Vertical Conducting Diodes. Japanese Journal of Applied Physics, 2008, 47, 2838.	1.5	2
81	Low-temperature characteristics of the current gain of GaN/InGaIn double-heterojunction bipolar transistors. Journal of Crystal Growth, 2009, 311, 3000-3002.	1.5	2
82	Terahertz spectroscopy of graphene complementary split ring resonators with gate tunability. Japanese Journal of Applied Physics, 2017, 56, 095102.	1.5	2
83	Initial stage of hexagonal boron nitride growth in diffusion and precipitation method. Japanese Journal of Applied Physics, 2017, 56, 06GE06.	1.5	2
84	Fabrication of GaN/Alumina/GaN Structure to Reduce Dislocations in GaN. Japanese Journal of Applied Physics, 2004, 43, 1930-1933.	1.5	1
85	Pnp AlGaIn/InGaIn/GaN Double Heterojunction Bipolar Transistors With Low-Base-Resistance (<100) Tj ETQq1 1 0.784314 rgBT /Overl	1.5	1
86	High-temperature (300 Å°C) operation of npn-type GaN/InGaIn double heterojunction bipolar transistors. Physica Status Solidi C: Current Topics in Solid State Physics, 2008, 5, 2957-2959.	0.8	1
87	GaN on h-BN technology for release and transfer of nitride devices. , 2014, , .		1
88	Surface structures of graphene covered Cu(103). Japanese Journal of Applied Physics, 2018, 57, 100301.	1.5	1
89	Wurtzite GaP nanowire grown by using tertiarybutylchloride and used to fabricate solar cell. Japanese Journal of Applied Physics, 2019, 58, 015004.	1.5	1
90	High blocking temperature of Fe nanoparticles embedded in diamond thin films. AIP Advances, 2022, 12, .	1.3	1

#	ARTICLE	IF	CITATIONS
91	Selective growth of MOVPE on AlGaAs/GaAs patterned substrates for quantum nano-structures. Materials Research Society Symposia Proceedings, 1996, 448, 259.	0.1	0
92	Quantum dots fabricated by selective area MOVPE and their application to single electron devices. Bulletin of Materials Science, 1999, 22, 531-535.	1.7	0
93	p-InGaN/n-GaN Heterojunction Diodes and their Application to Heterojunction Bipolar Transistors. Materials Research Society Symposia Proceedings, 2000, 639, 13101.	0.1	0
94	High common-emitter current gains obtained by pnp GaN bipolar junction transistors. Materials Research Society Symposia Proceedings, 2001, 693, 265.	0.1	0
95	High current gain (≥ 2000) and reduced common-emitter offset voltage of GaN/InGaN double heterojunction bipolar transistors. , 0, , .		0
96	High-Power Characteristics of GaN/InGaN Double Heterojunction Bipolar Transistors with a Regrown p-InGaN Base Layer. Materials Research Society Symposia Proceedings, 2003, 798, 707.	0.1	0
97	Growth of nitride semiconductors and its application to heterojunction bipolar transistors. Electronics and Communications in Japan, 2006, 89, 20-25.	0.2	0
98	Layered boron nitride as a release layer for mechanical transfer of GaN-based devices. , 2014, , .		0
99	Flow-rate modulation epitaxy of nonpolar m-plane AlN homoepitaxial layers grown on AlN bulk substrates. , 2016, , .		0
100	High Current Gains Obtained by InGaN/GaN Double Heterojunction Bipolar Transistors. Physica Status Solidi A, 2001, 188, 183-186.	1.7	0
101	Low Resistance Non-Alloy Ohmic Contact to p-Type GaN Using Mg-Doped InGaN Contact Layer. Physica Status Solidi A, 2001, 188, 363-366.	1.7	0